18-bit bus-interface D-type flip-flop with reset and enable with 30  $\Omega$  termination resistors; 3-state

Rev. 3 — 23 January 2018

Product data sheet

### **1** General description

The 74ALVT162823 18-bit bus interface register is designed to eliminate the extra packages required to buffer existing registers and provide extra data width for wider data or address paths of buses carrying parity.

The 74ALVT162823 has two 9-bit wide buffered registers with clock enable ( $n\overline{CE}$ ) and master reset ( $n\overline{MR}$ ) which are ideal for parity bus interfacing in high microprogrammed systems.

The registers are fully edge-triggered. The state of each D input, one set-up time before the LOW-to-HIGH clock transition is transferred to the corresponding Q output of the flip-flop.

The 74ALVT162823 is designed with 30  $\Omega$  series resistance in both the pull-up and pull-down output structures. This design reduces line noise in applications such as memory address drivers, clock drivers, and bus receivers or transmitters.

### 2 Features and benefits

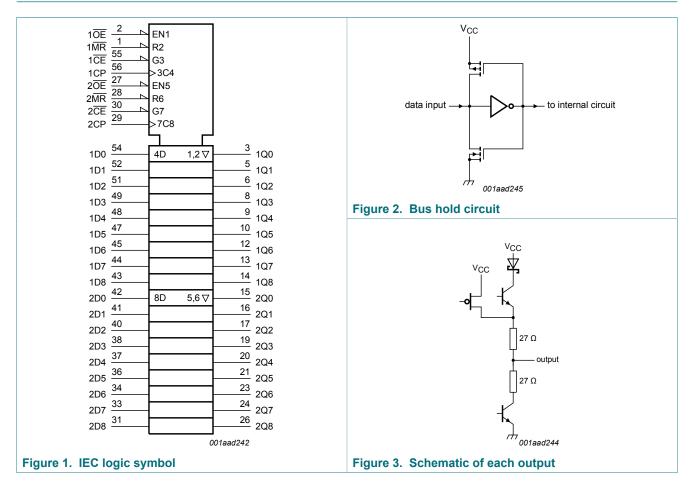
- Two sets of high speed parallel registers with positive edge-triggered D-type flip-flops
- 5 V I/O compatible
- Ideal where high speed, light loading or increased fan-in are required with MOS microprocessors
- Bus hold data inputs eliminate the need for external pull-up resistors to hold unused inputs
- Live insertion and extraction permitted
- Power-up 3-state
- Power-up reset
- Output capability: +12 mA to -12 mA
- Outputs include series resistance of 30  $\Omega$  making external termination resistors unnecessary
- Latch-up protection:
  - JESD78: exceeds 500 mA
- ESD protection:
  - MIL STD 883, method 3015: exceeds 2000 V
  - MM: exceeds 200 V

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# **3** Ordering information

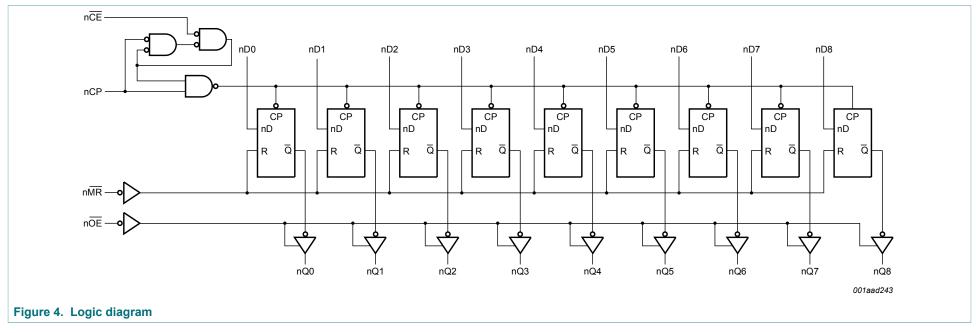
| Table 1. Ordering information |                   |         |   |          |  |  |  |  |
|-------------------------------|-------------------|---------|---|----------|--|--|--|--|
| Type number Package           |                   |         |   |          |  |  |  |  |
|                               | Temperature range | Name    | Description   | Version  |  |  |  |  |
| 74ALVT162823DGG               | −40 °C to +85 °C  | TSSOP56 | plastic thin shrink small outline package; 56 leads;<br>body width 6.1 mm | SOT364-1 |  |  |  |  |

# 4 Functional diagram



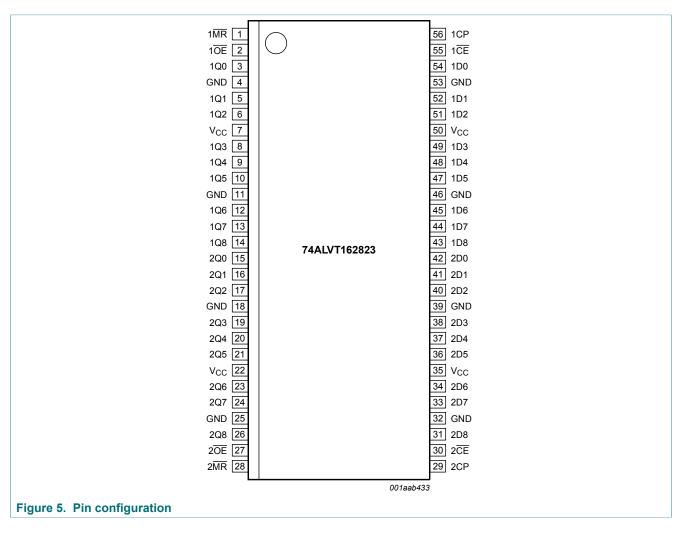
### 74ALVT162823

18-bit bus-interface D-type flip-flop with reset and enable with 30  $\Omega$  termination resistors; 3-state



### 5 **Pinning information**

### 5.1 Pinning



### 5.2 Pin description

| Table 2. Pin description                       |                                       |   |
|--|---------------------------------------|---|
| Symbol   | Pin                                   | Description                             |
| 1D0, 1D1, 1D2, 1D3, 1D4,<br>1D5, 1D6, 1D7, 1D8 | 54, 52, 51, 49, 48,<br>47, 45, 44, 43 | data inputs                             |
| 1Q0, 1Q1, 1Q2, 1Q3, 1Q4,<br>1Q5, 1Q6, 1Q7, 1Q8 | 3, 5, 6, 8, 9,<br>10, 12, 13, 14      | data outputs                            |
| 2D0, 2D1, 2D2, 2D3, 2D4,<br>2D5, 2D6, 2D7, 2D8 | 42, 41, 40, 38, 37,<br>36, 34, 33, 31 | data inputs                             |
| 2Q0, 2Q1, 2Q2, 2Q3, 2Q4,<br>2Q5, 2Q6, 2Q7, 2Q8 | 15, 16, 17, 19, 20,<br>21, 23, 24, 26 | data outputs                            |
| 1MR, 2MR                                       | 1, 28                                 | master reset input (active-LOW)         |
| 1 <u>0E</u> , 2 <u>0E</u>                      | 2, 27                                 | output enable inputs (active LOW)       |
| 1CP, 2CP                                       | 56, 29                                | clock pulse inputs (active rising edge) |
| 1CE, 2CE                                       | 55, 30                                | clock enable input (active-LOW)         |
| GND  | 4, 11, 18, 25,<br>32, 39, 46, 53      | ground (0 V)                            |
| V <sub>CC</sub>                                | 7, 22, 35, 50                         | supply voltage                          |

# 6 Functional description

### Table 3. Function table <sup>[1]</sup>

| Operating mode     | Input |     |     |     |     | Output |
|--------------------|-------|-----|-----|-----|-----|--------|
|                    | nOE   | nMR | nCE | nCP | nDn | nQn    |
| Clear              | L     | L   | Х   | Х   | Х   | L      |
| Load and read data | L     | Н   | L   | 1   | h   | Н      |
|                    |       |     |     |     | I   | L      |
| Hold               | L     | Н   | Н   | NC  | Х   | NC     |
| High-impedance     | Н     | Х   | Х   | Х   | Х   | Z      |

[1] H = HIGH voltage level;

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition;

L = LOW voltage level;

I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition;

NC = no change;

X = don't care;

Z = high-impedance OFF-state;

 $\uparrow$  = LOW-to-HIGH clock transition;

#### **Limiting values** 7

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134); voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions                            | Min  | Мах  | Unit |
|------------------|-------------------------|---------------------------------------|------|------|------|
| V <sub>CC</sub>  | supply voltage          |                                       | -0.5 | +4.6 | V    |
| VI               | input voltage           | [1]                                   | -0.5 | +7.0 | V    |
| Vo               | output voltage          | output in OFF-state or HIGH-state [1] | -0.5 | +7.0 | V    |
| I <sub>IK</sub>  | input clamping current  | V <sub>I</sub> < 0 V                  | -    | -50  | mA   |
| I <sub>OK</sub>  | output clamping current | V <sub>O</sub> < 0 V                  | -    | -50  | mA   |
| I <sub>O</sub>   | output current          | output in LOW-state                   | -    | 128  | mA   |
|                  |                         | output in HIGH-state                  | -    | -64  | mA   |
| T <sub>stg</sub> | storage temperature     |                                       | -65  | +150 | °C   |
| Tj               | junction temperature    | [2]                                   | -    | 150  | °C   |

 The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.
 The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

#### **Recommended operating conditions** 8

#### Table 5. Recommended operating conditions

| Symbol                | Parameter                          | Conditions      | Min | Тур | Max | Unit |
|-----------------------|------------------------------------|-----------------|-----|-----|-----|------|
| V <sub>CC</sub> = 2.  | 5 V                                |                 |     |     |     |      |
| V <sub>CC</sub>       | supply voltage                     |                 | 2.3 | -   | 2.7 | V    |
| VI                    | input voltage                      |                 | 0   | -   | 5.5 | V    |
| I <sub>OH</sub>       | HIGH-level output current          |                 | -   | -   | -8  | mA   |
| I <sub>OL</sub>       | LOW-level output current           |                 | -   | -   | 12  | mA   |
| Δt/Δv                 | input transition rise or fall rate | outputs enabled | -   | -   | 10  | ns/V |
| T <sub>amb</sub>      | ambient temperature                | in free air     | -40 | -   | +85 | °C   |
| V <sub>CC</sub> = 3.3 | 3 V                                |                 |     |     |     |      |
| V <sub>CC</sub>       | supply voltage                     |                 | 3.0 | -   | 3.6 | V    |
| VI                    | input voltage                      |                 | 0   | -   | 5.5 | V    |
| I <sub>OH</sub>       | HIGH-level output current          |                 | -   | -   | -12 | mA   |
| I <sub>OL</sub>       | LOW-level output current           |                 | -   | -   | 12  | mA   |
| Δt/Δv                 | input transition rise or fall rate | outputs enabled | -   | -   | 10  | ns/V |
| T <sub>amb</sub>      | ambient temperature                | in free air     | -40 | -   | +85 | °C   |

# 9 Static characteristics

### Table 6. Static characteristics

At recommended operating conditions;  $T_{amb} = -40$  °C to +85 °C; voltages are referenced to GND (ground = 0 V).

| Symbol                | Parameter                             | Conditions   |     | Min | Typ <sup>[1]</sup> | Max  | Unit |
|-----------------------|---------------------------------------|--|-----|-----|--------------------|------|------|
| V <sub>CC</sub> = 2.  | 5 V ± 0.2 V                           |  |     |     |                    | 1    |      |
| V <sub>IK</sub>       | input clamping voltage                | V <sub>CC</sub> = 2.3 V; I <sub>IK</sub> = -18 mA  |     | -   | -0.85              | -1.2 | V    |
| V <sub>IH</sub>       | HIGH-level input voltage              |  |     | 1.7 | -                  | -    | V    |
| V <sub>IL</sub>       | LOW-level input voltage               |  |     | -   | -                  | 0.7  | V    |
| V <sub>OH</sub>       | HIGH-level output voltage             | V <sub>CC</sub> = 2.3 V; I <sub>O</sub> = -8 mA  |     | 1.7 | 2.5                | -    | V    |
| V <sub>OL</sub>       | LOW-level output voltage              | V <sub>CC</sub> = 2.3 V; I <sub>O</sub> = 12 mA  |     | -   | 0.3                | 0.5  | V    |
| V <sub>OL(pu)</sub>   | power-up LOW-level<br>output voltage  | $V_{CC}$ = 2.7 V; I <sub>O</sub> = 1 mA; V <sub>I</sub> = V <sub>CC</sub> or GND             | [2] | -   | 0.2                | 0.55 | V    |
| I                     | input leakage current                 | control pins   |     |     |                    |      |      |
|                       |                                       | V <sub>CC</sub> = 2.7 V; V <sub>I</sub> = GND  |     | -   | 0.1                | ±1   | μA   |
|                       |                                       | V <sub>CC</sub> = 2.7 V; V <sub>I</sub> = 5.5 V  |     | -   | 0.1                | 10   | μA   |
|                       |                                       | I/O data pins  | [3] |     |                    |      |      |
|                       |                                       | V <sub>CC</sub> = 2.7 V; V <sub>I</sub> = 5.5 V  |     | -   | 0.1                | 10   | μA   |
|                       |                                       | $V_{CC} = 2.7 \text{ V}; \text{ V}_{I} = V_{CC}$   |     | -   | 0.5                | 1    | μA   |
|                       |                                       | V <sub>CC</sub> = 2.7 V; V <sub>I</sub> = 0 V  |     | -   | 0.1                | -5   | μA   |
| I <sub>OFF</sub>      | power-off leakage current             | $V_{CC}$ = 0 V; V <sub>I</sub> or V <sub>O</sub> = 0 V to 4.5 V                              |     | -   | 0.1                | ±100 | μA   |
| I <sub>BHL</sub>      | bus hold LOW current                  | data inputs; $V_{CC}$ = 2.5 V; $V_{I}$ = 0.7 V   | [4] | -   | 100                | -    | μA   |
| I <sub>BHH</sub>      | bus hold HIGH current                 | data inputs; $V_{CC}$ = 2.5 V; $V_{I}$ = 1.7 V   | [4] | -   | -70                | -    | μA   |
| I <sub>EX</sub>       | external current                      | output HIGH-state when $V_O > V_{CC}$ ;<br>$V_O = 5.5 V$ ; $V_{CC} = 2.5 V$                  |     | -   | 10                 | 125  | μA   |
| I <sub>O(pu\pd)</sub> | power-up/power-down<br>output current | $V_{CC} \le 1.2 \text{ V}; V_O = 0.5 \text{ V to } V_{CC};$<br>$V_I = \text{GND or } V_{CC}$ | [5] | -   | 1                  | ±100 | μA   |
| l <sub>oz</sub>       | OFF-state output current              | $V_{CC}$ = 2.7 V; $V_{I}$ = $V_{IL}$ or $V_{IH}$   |     |     |                    |      |      |
|                       |                                       | output HIGH state; V <sub>O</sub> = 2.3 V  |     | -   | 0.5                | 5    | μA   |
|                       |                                       | output LOW-state; $V_0 = 0.5 V$  |     | -   | 0.5                | -5   | μA   |
| I <sub>CC</sub>       | supply current                        | $V_{CC}$ = 2.7 V; $V_{I}$ = GND or $V_{CC}$ ; $I_{O}$ = 0 A                                  |     |     |                    |      |      |
|                       |                                       | outputs HIGH-state   |     | -   | 0.04               | 0.1  | mA   |
|                       |                                       | outputs LOW-state  |     | -   | 2.7                | 4.5  | mA   |
|                       |                                       | outputs disabled   | [6] | -   | 0.04               | 0.1  | mA   |

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### 18-bit bus-interface D-type flip-flop with reset and enable with 30 $\Omega$ termination resistors; 3-state

| Symbol                | nbol Parameter Conditions             |  |  | Min  | Min Typ <sup>[1]</sup> |      | Unit |  |
|-----------------------|---------------------------------------|--|--|------|------------------------|------|------|--|
| ΔI <sub>CC</sub>      | additional supply current             | per input pin; $V_{CC}$ = 2.3 V to 2.7 V;<br>one input at $V_{CC}$ - 0.6 V,<br>other inputs at $V_{CC}$ or GND | [7]  | -    | 0.04                   | 0.4  | mA   |  |
| Cl                    | input capacitance                     | $V_{I} = 0 V \text{ or } V_{CC}$   |  | -    | 3                      | -    | pF   |  |
| Co                    | output capacitance                    | V <sub>I/O</sub> = 0 V or 3.0 V  |  | -    | 9                      | -    | pF   |  |
| V <sub>CC</sub> = 3.3 | 3 V ± 0.3 V                           |  |  |      |                        |      |      |  |
| V <sub>IK</sub>       | input clamping voltage                | V <sub>CC</sub> = 3.0 V; I <sub>IK</sub> = -18 mA  |  | -    | -0.85                  | -1.2 | V    |  |
| V <sub>IH</sub>       | HIGH-level input voltage              |  |  | 2.0  | -                      | -    | V    |  |
| V <sub>IL</sub>       | LOW-level input voltage               |  |  | -    | -                      | 0.8  | V    |  |
| V <sub>OH</sub>       | HIGH-level output voltage             | V <sub>CC</sub> = 3.0 V; I <sub>O</sub> = -12 mA   | $V_{\rm CC} = 3.0 \text{ V}; I_{\rm O} = -12 \text{ mA}$   |      | 2.3                    | -    | V    |  |
| V <sub>OL</sub>       | LOW-level output voltage              | V <sub>CC</sub> = 3.0 V; I <sub>O</sub> = 12 mA  |  | -    | 0.5                    | 0.8  | V    |  |
| V <sub>OL(pu)</sub>   | power-up LOW-level<br>output voltage  | $V_{CC}$ = 3.6 V; I <sub>O</sub> = 1 mA; V <sub>I</sub> = V <sub>CC</sub> or GND                               | $6 \text{ V}; \text{ I}_{\text{O}} = 1 \text{ mA}; \text{ V}_{\text{I}} = \text{V}_{\text{CC}} \text{ or GND} $ <sup>[2]</sup> |      | -                      | 0.55 | V    |  |
| I                     | input leakage current                 | control pins   |  |      |                        |      |      |  |
|                       |                                       | $V_{CC}$ = 3.6 V; $V_{I}$ = $V_{CC}$ or GND  |  | -    | 0.1                    | ±1   | μA   |  |
|                       |                                       | V <sub>CC</sub> = 0 V or 3.6 V; V <sub>I</sub> = 5.5 V   |  | -    | 0.1                    | 10   | μA   |  |
|                       |                                       | I/O data pins  | [3]  |      |                        |      |      |  |
|                       |                                       | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = 5.5 V  |  | -    | 0.1                    | 10   | μA   |  |
|                       |                                       | $V_{CC} = 3.6 \text{ V}; \text{ V}_{I} = V_{CC}$   |  | -    | 0.5                    | 1    | μA   |  |
|                       |                                       | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = 0 V  |  | -    | 0.1                    | -5   | μA   |  |
| I <sub>OFF</sub>      | power-off leakage current             | $V_{CC}$ = 0 V; V <sub>1</sub> or V <sub>0</sub> = 0 V to 4.5 V  |  | -    | 0.1                    | ±100 | μA   |  |
| I <sub>BHL</sub>      | bus hold LOW current                  | data inputs; $V_{CC}$ = 3 V; $V_{I}$ = 0.8 V   |  | 75   | 130                    | -    | μA   |  |
| I <sub>BHH</sub>      | bus hold HIGH current                 | data inputs; $V_{CC}$ = 3 V; $V_{I}$ = 2.0 V   |  | -75  | -140                   | -    | μA   |  |
| I <sub>BHLO</sub>     | bus hold LOW overdrive<br>current     | data inputs; $V_{CC}$ = 3.6 V; $V_{I}$ = 0 V to 3.6 V  | [8]  | 500  | -                      | -    | μA   |  |
| I <sub>BHHO</sub>     | bus hold HIGH overdrive<br>current    | data inputs; $V_{CC}$ = 3.6 V; $V_{I}$ = 0 V to 3.6 V  | [8]  | -500 | -                      | -    | μA   |  |
| I <sub>EX</sub>       | external current                      | output HIGH-state when $V_O > V_{CC}$ ;<br>$V_O = 5.5 V$ ; $V_{CC} = 3.0 V$                                    |  | -    | 10                     | 125  | μA   |  |
| I <sub>O(pu\pd)</sub> | power-up/power-down<br>output current | $V_{CC} \le 1.2 \text{ V}; V_O = 0.5 \text{ V} \text{ to } V_{CC};$<br>$V_I = \text{GND or } V_{CC}$           | [9]  | -    | 1                      | ±100 | μA   |  |
| l <sub>oz</sub>       | OFF-state output current              | $V_{CC}$ = 3.6 V; $V_{I}$ = $V_{IL}$ or $V_{IH}$   |  |      |                        |      |      |  |
|                       |                                       | output HIGH state; V <sub>O</sub> = 3.0 V  |  | -    | 0.5                    | 5    | μA   |  |
|                       |                                       | output LOW-state; V <sub>O</sub> = 0.5 V   |  | -    | 0.5                    | -5   | μA   |  |
| I <sub>CC</sub>       | supply current                        | $V_{CC}$ = 3.6 V; $V_{I}$ = GND or $V_{CC}$ ; $I_{O}$ = 0 A  |  |      |                        |      |      |  |
|                       |                                       | outputs HIGH-state   |  | -    | 0.05                   | 0.1  | mA   |  |
|                       |                                       | outputs LOW-state  |  | -    | 3.9                    | 5.5  | mA   |  |
|                       |                                       | outputs disabled   | [6]  | -    | 0.06                   | 0.1  | mA   |  |

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#### 18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state

| Symbol           | Parameter                 | Conditions   | Min | Typ <sup>[1]</sup> | Max | Unit |
|------------------|---------------------------|--|-----|--------------------|-----|------|
| ΔI <sub>CC</sub> | additional supply current | per input pin; $V_{CC}$ = 3 V to 3.6 V; [7]<br>one input at $V_{CC}$ - 0.6 V,<br>other inputs at $V_{CC}$ or GND | -   | 0.04               | 0.4 | mA   |
| CI               | input capacitance         | V <sub>I</sub> = 0 V or V <sub>CC</sub>  | -   | 3                  | -   | pF   |
| Co               | output capacitance        | $V_{I/O} = 0 V \text{ or } 3.0 V$  | -   | 9                  | -   | pF   |

[1] All typical values for V<sub>CC</sub> = 2.5 V  $\pm$  0.2 V are measured at V<sub>CC</sub> = 2.5 V and T<sub>amb</sub> = 25 °C.

All typical values for  $V_{CC}$  = 3.3 V ± 0.3 V are measured at  $V_{CC}$  = 3.3 V and  $T_{amb}$  = 25 °C.

[2] For valid test results, data must not be loaded into the flip-flops after applying power.

[3] Unused pins at V<sub>CC</sub> or GND.

[4] Not guaranteed.

[5] This parameter is valid for any V<sub>CC</sub> between 0 V and 1.2 V with a transition time of up to 10 ms. From V<sub>CC</sub> = 1.2 V to V<sub>CC</sub> = 2.5 V ± 0.2 V a transition time of 100 μs is permitted. This parameter is valid for T<sub>amb</sub> = 25 °C only.

[6]  $I_{CC}$  is measured with outputs pulled up to  $V_{CC}$  or pulled down to ground.

[7] This is the increase in supply current for each input at the specified voltage level other than  $V_{CC}$  or GND.

[8] This is the bus hold overdrive current required to force the input to the opposite logic state.

[9] This parameter is valid for any V<sub>CC</sub> between 0 V and 1.2 V with a transition time of up to 10 ms. From V<sub>CC</sub> = 1.2 V to V<sub>CC</sub> = 3.3 V ± 0.3 V a transition time of 100 µs is permitted. This parameter is valid for T<sub>amb</sub> = 25 °C only.

# **10 Dynamic characteristics**

### Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V);  $T_{amb} = -40$  °C to +85 °C; for test circuit see Figure 10.

| Symbol               | Parameter                           | Conditions               | Min | Typ <sup>[1]</sup> | Мах | Unit |
|----------------------|-------------------------------------|--------------------------|-----|--------------------|-----|------|
| V <sub>CC</sub> = 2. | 5 V ± 0.2 V                         |                          | 1   | I                  |     |      |
| t <sub>PLH</sub>     | LOW to HIGH propagation delay       | nCP to nQn; see Figure 6 | 2.1 | 3.7                | 5.8 | ns   |
| t <sub>PHL</sub>     | HIGH-to-LOW propagation delay       | nCP to nQn; see Figure 6 | 2.0 | 2.8                | 4.6 | ns   |
|                      |                                     | nMR to nQn; see Figure 8 | 2.0 | 3.0                | 4.6 | ns   |
| t <sub>PZH</sub>     | OFF-state to HIGH propagation delay | nOE to nQn; see Figure 9 | 2.8 | 4.4                | 6.6 | ns   |
| t <sub>PZL</sub>     | OFF-state to LOW propagation delay  | nOE to nQn; see Figure 9 | 2.0 | 3.4                | 5.2 | ns   |
| t <sub>PHZ</sub>     | HIGH to OFF-state propagation delay | nOE to nQn; see Figure 9 | 2.3 | 3.2                | 4.6 | ns   |
| t <sub>PLZ</sub>     | LOW to OFF-state propagation delay  | nOE to nQn; see Figure 9 | 2.0 | 2.5                | 3.5 | ns   |
| t <sub>su(H)</sub>   | set-up time HIGH                    | nDn to nCP; see Figure 7 | 1.0 | 0.5                | -   | ns   |
|                      |                                     | nCE to nCP; see Figure 7 | 1.0 | 0.2                | -   | ns   |
| t <sub>su(L)</sub>   | set-up time LOW                     | nDn to nCP; see Figure 7 | 2.0 | 1.3                | -   | ns   |
|                      |                                     | nCE to nCP; see Figure 7 | 0.5 | -0.1               | -   | ns   |
| t <sub>h(H)</sub>    | hold time HIGH                      | nDn to nCP; see Figure 7 | 0.1 | -1.4               | -   | ns   |
|                      |                                     | nCE to nCP; see Figure 7 | 1.0 | 0.2                | -   | ns   |
| t <sub>h(L)</sub>    | hold time LOW                       | nDn to nCP; see Figure 7 | 0.1 | -0.5               | -   | ns   |
|                      |                                     | nCE to nCP; see Figure 7 | 1.0 | -0.1               | -   | ns   |
| t <sub>W</sub>       | pulse width                         | nCP HIGH; see Figure 6   | 2.0 | 0.8                | -   | ns   |
|                      |                                     | nCP LOW                  | 3.0 | 2.1                | -   | ns   |
|                      |                                     | nMR LOW; see Figure 8    | 2.0 | 0.8                | -   | ns   |
| t <sub>rec</sub>     | recovery time                       | nMR to nCP; see Figure 8 | 2.3 | 1.3                | -   | ns   |

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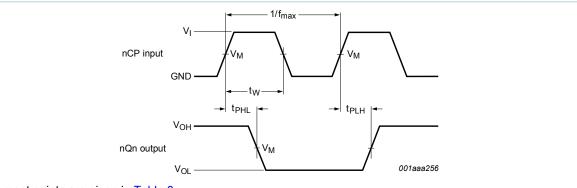
### 18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state

| Symbol               | Parameter                           | Conditions                      | Min | Typ <sup>[1]</sup> | Мах      | Unit |
|----------------------|-------------------------------------|---------------------------------|-----|--------------------|----------|------|
| V <sub>CC</sub> = 3. | 3 V ± 0.3 V                         |                                 |     |                    | <u> </u> |      |
| t <sub>PLH</sub>     | LOW to HIGH propagation delay       | nCP to nQn; see <u>Figure 6</u> | 1.8 | 2.9                | 4.4      | ns   |
| t <sub>PHL</sub>     | HIGH-to-LOW propagation delay       | nCP to nQn; see Figure 6        | 1.6 | 2.3                | 3.6      | ns   |
|                      |                                     | nMR to nQn; see Figure 8        | 1.8 | 2.5                | 3.7      | ns   |
| t <sub>PZH</sub>     | OFF-state to HIGH propagation delay | nOE to nQn; see Figure 9        | 2.0 | 3.5                | 5.2      | ns   |
| t <sub>PZL</sub>     | OFF-state to LOW propagation delay  | nOE to nQn; see Figure 9        | 1.7 | 2.8                | 3.8      | ns   |
| t <sub>PHZ</sub>     | HIGH to OFF-state propagation delay | nOE to nQn; see Figure 9        | 2.4 | 3.5                | 4.7      | ns   |
| t <sub>PLZ</sub>     | LOW to OFF-state propagation delay  | nOE to nQn; see Figure 9        | 1.9 | 2.8                | 3.8      | ns   |
| t <sub>su(H)</sub>   | set-up time HIGH                    | nDn to nCP; see Figure 7        | 1.0 | 0.5                | -        | ns   |
|                      |                                     | nCE to nCP; see Figure 7        | 1.0 | 0.1                | -        | ns   |
| t <sub>su(L)</sub>   | set-up time LOW                     | nDn to nCP; see Figure 7        | 1.6 | 1.1                | -        | ns   |
|                      |                                     | nCE to nCP; see Figure 7        | 0.5 | -0.5               | -        | ns   |
| t <sub>h(H)</sub>    | hold time HIGH                      | nDn to nCP; see Figure 7        | 0.1 | -0.5               | -        | ns   |
|                      |                                     | nCE to nCP; see Figure 7        | 1.0 | -0.1               | -        | ns   |
| t <sub>h(L)</sub>    | hold time LOW                       | nDn to nCP; see Figure 7        | 0.1 | -0.7               | -        | ns   |
|                      |                                     | nCE to nCP; see Figure 7        | 1.0 | 0.5                | -        | ns   |
| t <sub>W</sub>       | pulse width                         | nCP HIGH; see Figure 6          | 1.5 | 0.7                | -        | ns   |
|                      |                                     | nCP LOW                         | 2.5 | 1.4                | -        | ns   |
|                      |                                     | nMR LOW; see Figure 8           | 2.0 | 1.5                | -        | ns   |
| t <sub>rec</sub>     | recovery time                       | nMR to nCP; see Figure 8        | 2.0 | 1.1                | -        | ns   |

[1] All typical values for V<sub>CC</sub> = 2.5 V ± 0.2 V are measured at V<sub>CC</sub> = 2.5 V and T<sub>amb</sub> = 25 °C. All typical values for V<sub>CC</sub> = 3.3 V ± 0.3 V are measured at V<sub>CC</sub> = 3.3 V and T<sub>amb</sub> = 25 °C.

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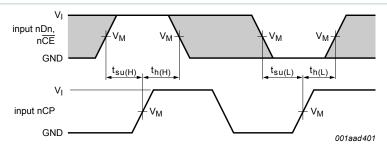
### 10.1 Waveforms and test circuit



Measurement points are given in Table 8.

 $V_{OL}$  and  $V_{OH}$  are typical voltage output levels that occur with the output load.

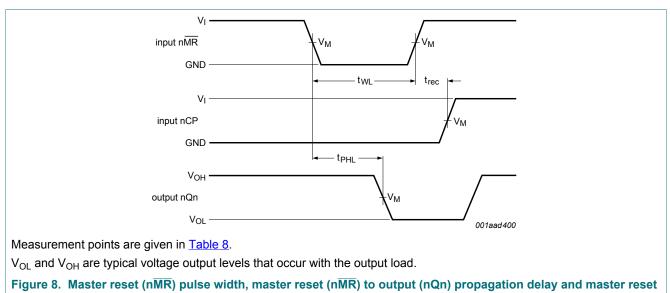
Figure 6. Propagation delay clock input (nCP) to output (nQn), clock pulse (nCP) width HIGH and maximum clock frequency



Measurement points are given in Table 8.

The shaded areas indicate when the input is permitted to change for predictable output performance.

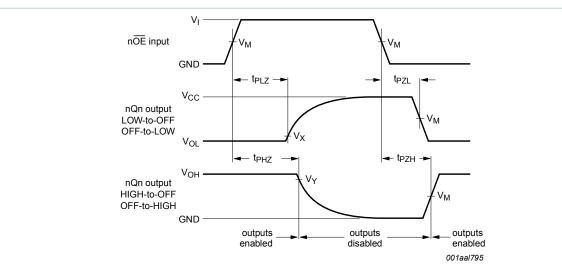
#### Figure 7. Data set-up and hold times



(nMR) to clock (nCP) recovery time

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Measurement points are given in Table 8.

 $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical voltage output levels that occur with the output load.

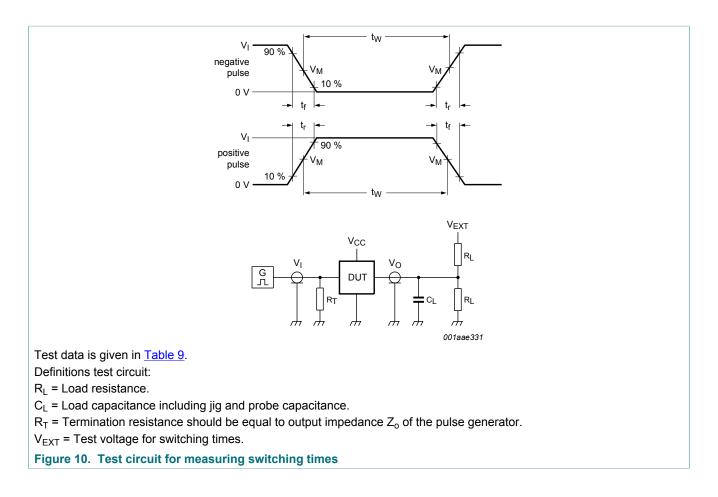
Figure 9. OFF-state to HIGH and LOW propagation delays and LOW and HIGH to OFF-state propagation delays

#### Table 8. Measurement points

| V <sub>cc</sub> | Input                 | Output                |                          |                          |  |  |
|-----------------|-----------------------|-----------------------|--------------------------|--------------------------|--|--|
|                 | V <sub>M</sub>        | V <sub>M</sub>        | V <sub>Y</sub>           |                          |  |  |
| ≤ 2.7 V         | 0.5 x V <sub>CC</sub> | 0.5 x V <sub>CC</sub> | V <sub>OL</sub> + 0.15 V | V <sub>OH</sub> - 0.15 V |  |  |
| ≥ 3.0 V         | 1.5 V                 | 1.5 V                 | V <sub>OL</sub> + 0.3 V  | V <sub>OH</sub> - 0.3 V  |  |  |

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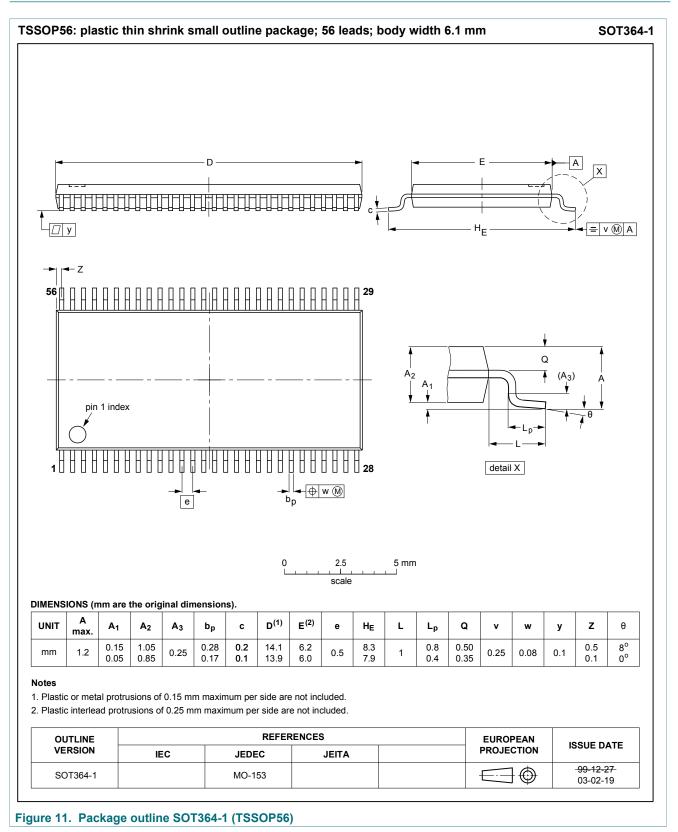


#### Table 9. Test data

| Input                               |                |        | Load                            |       | V <sub>EXT</sub> |                                     |                                     |                                     |
|-------------------------------------|----------------|--------|---------------------------------|-------|------------------|-------------------------------------|-------------------------------------|-------------------------------------|
| VI                                  | f <sub>i</sub> | tw     | t <sub>r</sub> , t <sub>f</sub> | CL    | RL               | t <sub>PHZ</sub> , t <sub>PZH</sub> | t <sub>PLZ</sub> , t <sub>PZL</sub> | t <sub>PLH</sub> , t <sub>PHL</sub> |
| 3.0 V or $V_{CC}$ whichever is less | ≤ 10 MHz       | 500 ns | ≤ 2.5 ns                        | 50 pF | 500 Ω            | GND                                 | 6 V or $V_{CC}$ x 2                 | open                                |

18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state

# 11 Package outline



# **12 Abbreviations**

| Table 10. Abbreviations |                           |  |  |  |
|-------------------------|---------------------------|--|--|--|
| Acronym                 | Description               |  |  |  |
| DUT                     | Device Under Test         |  |  |  |
| ESD                     | ElectroStatic Discharge   |  |  |  |
| MIL                     | Military                  |  |  |  |
| MM                      | Machine Model             |  |  |  |
| MOS                     | Metal-Oxide Semiconductor |  |  |  |

# **13 Revision history**

|--|

| Document ID      | Release date   | Data sheet status     | Change notice | Supersedes       |  |  |
|------------------|--|-----------------------|---------------|------------------|--|--|
| 74ALVT162823 v.3 | 20180123   | Product data sheet    | -             | 74ALVT162823 v.2 |  |  |
| Modifications:   | <ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Type number 74ALVT162823DL (SOT371-1 / SSOP56) removed.</li> </ul>           |                       |               |                  |  |  |
| 74ALVT162823 v.2 | 20050811   | Product data sheet    | -             | 74ALVT162823 v.1 |  |  |
| Modifications:   | <ul> <li>The format of this data sheet has been redesigned to comply with the new presentation and information standard of Philips Semiconductors.</li> <li><u>Section 2</u>: modified 'Jedec Std 17' into 'JESD78'</li> <li><u>Section 10</u>: changed propagation delays.</li> </ul> |                       |               |                  |  |  |
| 74ALVT162823 v.1 | 19980827   | Product specification | -             | -                |  |  |

## 14 Legal information

### 14.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

Please consult the most recently issued document before initiating or completing a design. [1]

The term 'short data sheet' is explained in section "Definitions".

[2] [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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74ALVT162823 **Product data sheet** 

#### 18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state

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18-bit bus-interface D-type flip-flop with reset and enable with 30  $\Omega$  termination resistors; 3-state

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